XL-PD15-22C/TR8 **技术数据表 Technical Data Sheet**

characteristic

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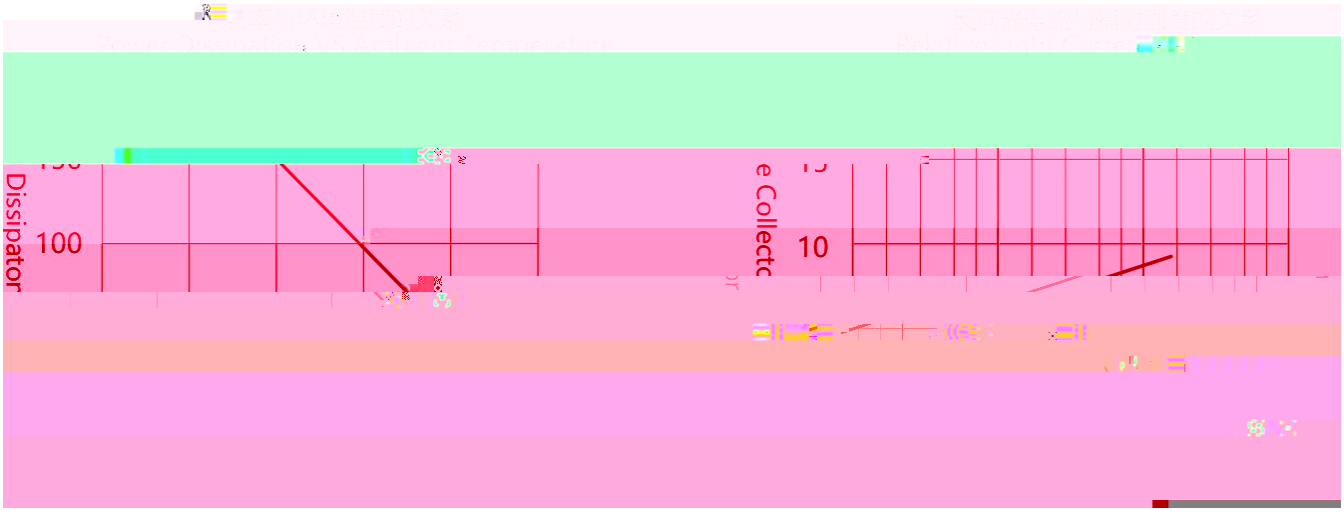
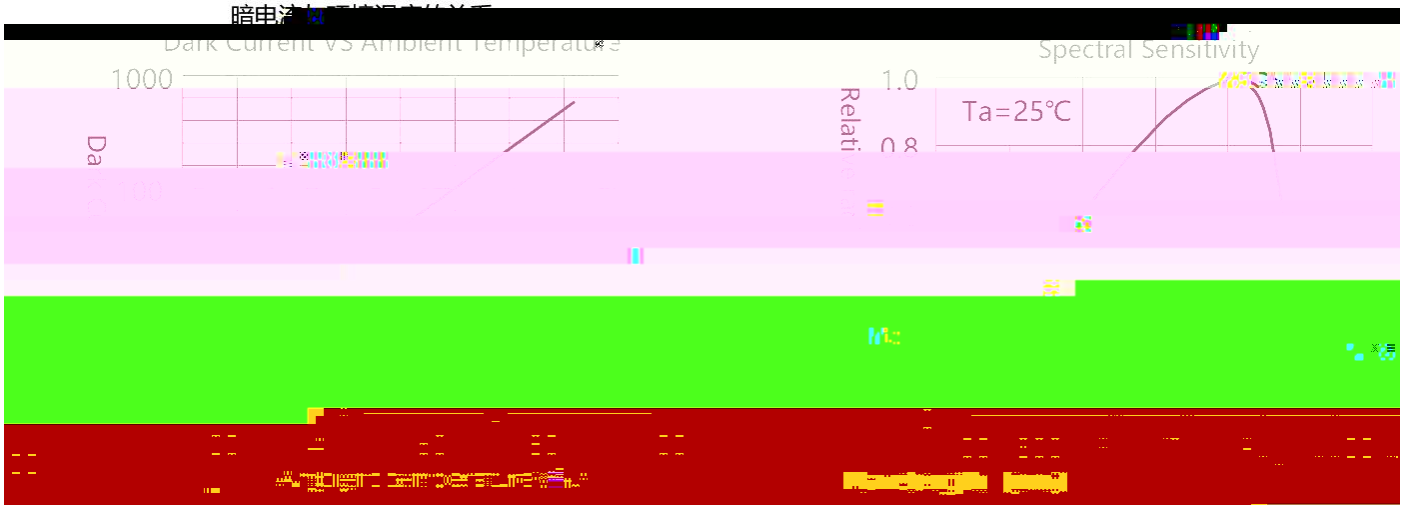
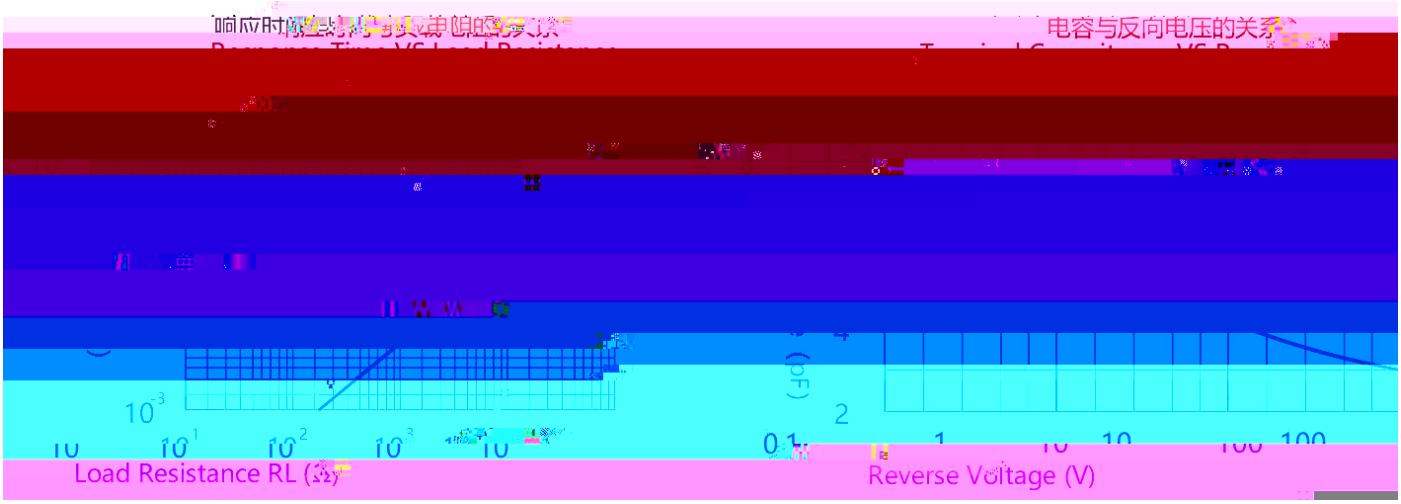
L/W/H˜ :3.2*

典型特性曲线

Typical Characteristics Curves

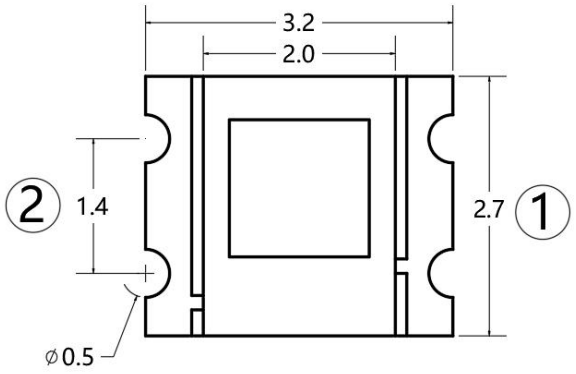


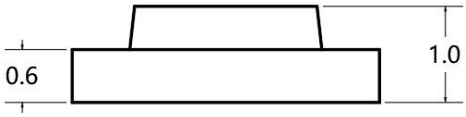


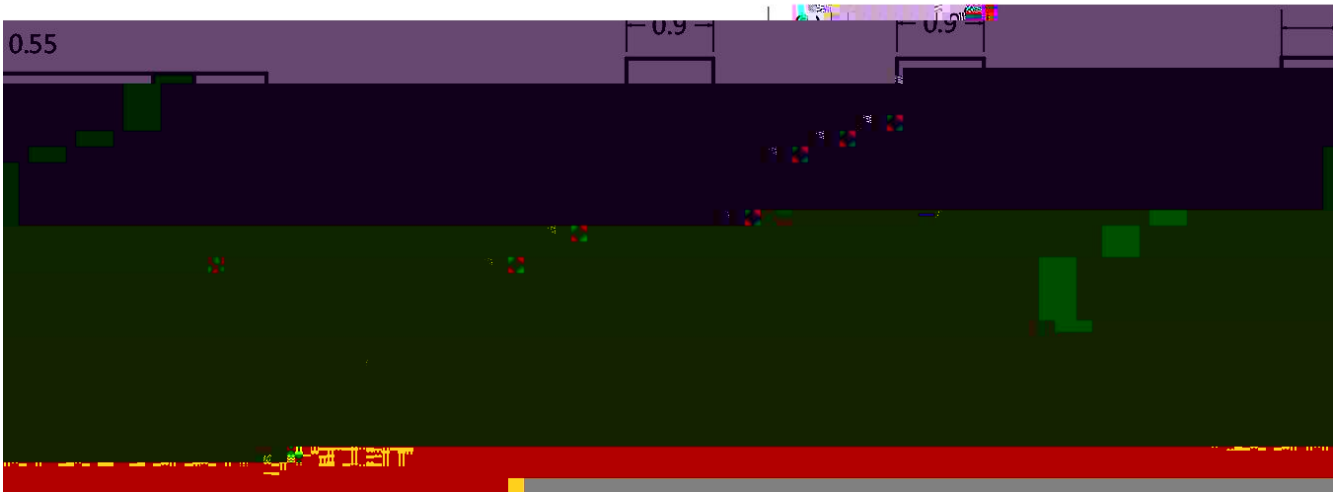


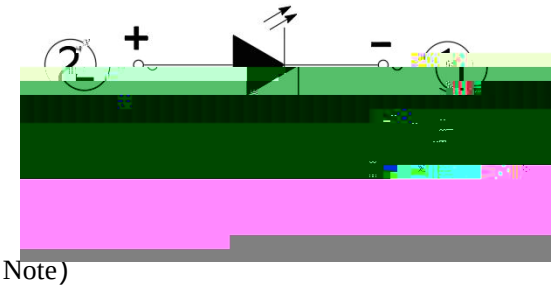
外形尺寸

Outline Dimension









(Note)

1.

Dimensions are in millimeters

2. ± 0.30mm

Tolerances unless mentioned are ± 0.30mm

载带与圆盘尺寸 Belt and disk dimensions

包装（2）

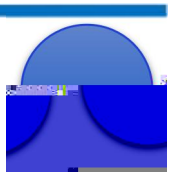
Packaging (2)

M

使用注意事项（1）

300 3 25W

Each terminal is to go below the top of soldering iron temperature less than 300 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and



使用注意事项（3）

Others

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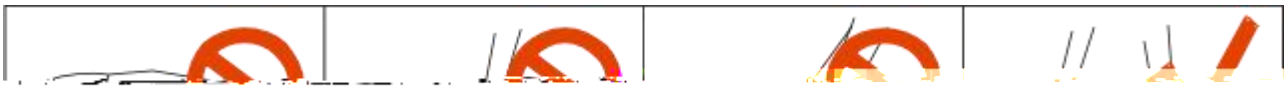
*When handling the product, touching the encapsulant with bare hands will not only contaminate its surface, but also affect on its optical characteristics. Excessive force to the encapsulant might result in catastrophic failure of the LEDs due to die breakage or wire deformation. For this reason, please do not put excessive stress on LEDs, especially when the LEDs are heated such as during Reflow Soldering.



*LED

*The epoxy resin of encapsulant is fragile, so please avoid scratch or friction over the epoxy resin surface. While handling the product with tweezers, do not hold by the epoxy resin, be careful.